



4/11 1772

29939/30083

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):)	CERTIFICATE OF MAILING
Skov et al.)	
Serial No.: 09/993,214)	I hereby certify that this paper and the
Title: Method and Apparatus for)	documents referred to as enclosed therewith
Separating Molded Articles)	are being deposited with the United States
Filed: November 14, 2001)	Postal Service as first class mail, postage
Group Art Unit: 1772)	prepaid, on February 13, 2003 in an envelope
Examiner: To Be Determined)	addressed to Commissioner for Patents,
)	Washington, D.C. 20231
)	<i>Bryan J. Lempi</i>
)	Bryan J. Lempi
)	Registration No.: 39,746

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

Pursuant to the duty of disclosure under 37 C.F.R. § 1.56, the information identified on the enclosed Form PTO 1449 is disclosed to the Examiner for consideration in connection with the above identified patent application. Copies of the documents listed on the Form PTO 1449 are enclosed herewith.


This Supplemental Information Disclosure Statement is being submitted before receipt of a first Office Action on the merits and, consequently, should be considered by the Patent Office without payment of a fee. See 37 C.F.R. §1.97(b)(3). Furthermore, each item of information contained in this Supplemental Information Disclosure Statement was first cited or originated in a communication from any foreign (PCT) patent office in a counterpart foreign (PCT) application not more than three months prior to the filing (mailing) of this Supplemental Information Disclosure Statement. For this further reason, no fee is due for consideration of this information. See, 37 C.F.R. §1.97(c)(1).

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However, if any additional fee is required for the consideration of this information,
the Commissioner is hereby authorized to charge such fee to Deposit Account No. 13 2855.
A copy of this paper is enclosed herewith.

Respectfully submitted,

By: 
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For PTO-1449 (Modified)	U.S. Department of Commerce Patent and Trademark Office	Atty. Docket No. 29939/30083	Serial No. 09/993,214
		Applicant Skov et al.	
		Filing Date Nov. 14, 2001	Group 1722

INFORMATION DISCLOSURE STATEMENT

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U.S. PATENT DOCUMENTS							
*Examiner Initials		Patent Number	Issue Date	Name	Class	Subclass	Filing Date if Appropriate
		2,541,249	02/13/51	Hobson	18	5	
		5,466,413	11/14/95	Richter et al.	264	521	
		5,792,413	08/1/98	Ang et al.	264	515	

FOREIGN PATENT DOCUMENTS								
*Examiner Initials		Document Number	Publication Date	Country	Class	Subclass	Translation	
							Yes	No
		GB 851 473 A	19.10.60	GB				
		GB 2 343 861 A	24.05.00	GB				
		WO 98/12028	26.03.98	PCT				

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)		
		Patent Abstracts of Japan vol. 012, no 098, 31 March 1988 & JP 62 233226 A 13 October 1987.
		Patent Abstracts of Japan vol. 1995, no. 11, 26 December 1995 & JP 07 214652 A 15 August 1995.
		PCT International Search Report issued in PCT/US02/26735, November 25, 2002

Examiner	Date Considered
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	